

1 DESCRIPTION

The MT5725 is an SoC (System on Chip) for magnetic induction based wireless power receiver.

It is fully compliant with the latest WPC Qi specification (Version 1.2.4) of BPP (Baseline Power Profile) and EPP (Extended Power Profile) and also supports various proprietary fast charging protocols used by major smart phone OEM's. It is capable of true fast wireless charging for up to 30W of delivered power with fully programmable output voltage (maximum 20V) and current limit (maximum 2A).

MT5725 has a very high overall AC to DC conversion efficiency (up to 97%), thanks to the optimized and adaptive full synchronous rectifier control, very small Rdson of power MOSFET's, and extremely low bias current.

With the exception of a few external passive components, this SoC integrates everything that is needed for a wireless power receiving function. It is composed of an ARM Cortex M0 processor with 8KB SRAM and 16KB OTP, full synchronous rectifier and special output LDO, robust and reliable over voltage, over current and over temperature protection circuits, bi-directional communication unit and various GPIO's and serial interfaces.

With the flexibility of SoC architecture and the unique implementation, the MT5725 is future proof in supporting WPC Qi specification's further updates and new proprietary protocols. It also supports reverse charging mode where a wireless power receiver is configured into a wireless power transmitter by firmware control.

2 FEATURES

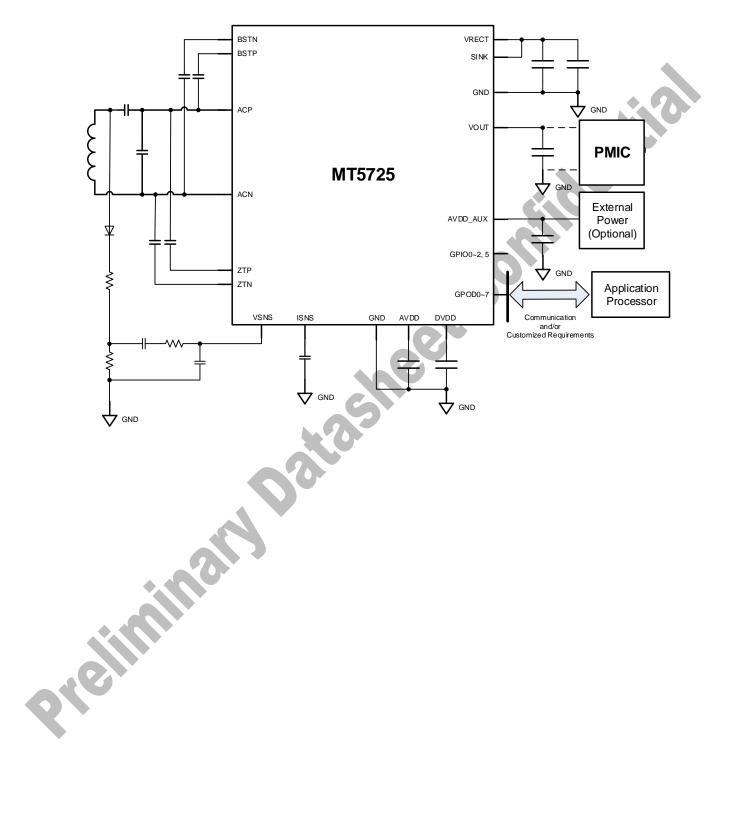
- Up to 30W power delivery
- Fully programmable output voltage (up to 20V) and current limit (up to 2A)
- Embedded ARM Cortex M0 processor with 8KB SRAM and 16KB OTP
- Up to 97% AC input to DC output efficiency
- Reverse charging mode with integrated dual channel TX demodulation
- Fully integrated bi-directional current sensing
- Reliable and unique over voltage, current, temperature protection
- Specially designed output LDO with output clamping and fast response to line and load transient
- WPC compliant and proprietary communication protocols support with hardware ASK and FSK modulation and demodulation
- Independent I2C slave and I2C master interface with additional GPIO's
- 2.48mm x 3.87mm (6x9 ball array) WLCSP

3 APPLICATIONS

- Standard and fast wireless charging for smart phones with up to 30W received power
- Wireless charging for wearable devices with high integration and small form factor
- TRx function for phones or power banks where they can be wirelessly charged and wirelessly charge other devices
- Other wireless power applications



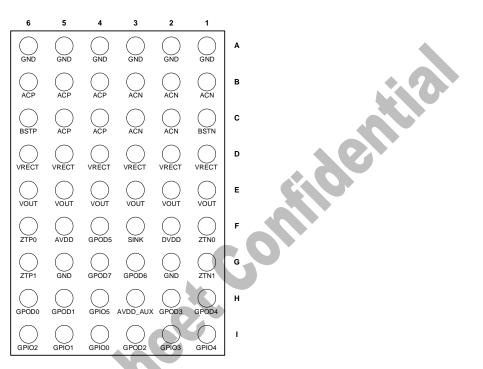
4 TYPICAL APPLICATION CIRCUIT



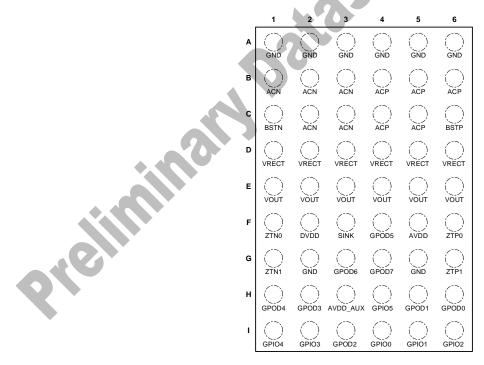


5 PIN CONFIGURATIONS AND FUNCTIONS

5.1 WLCSP Pin Configurations



Bottom View (pin/ball side)



Top View (marking side)





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5.2 Pin Functions

Pin Name	Pin No.	Description
ACN	B1,B2,B3,C2,C3	AC input, connect to one end of the coil.
ACP	B4,B5,B6,C4,C5	AC input, connect to the other end of the coil.
GND	A1,A2,A3, A4,A5,A6,G2,G5	Power Ground.
VRECT	D1,D2,D3,D4,D5,D6	Output of Synchronous Rectifier.
VOUT	E1,E2,E3,E4,E5,E6	Output of LDO.
SINK	F3	Providing sinking current.
BSTP	C6	Boost Capacitor for internal driver for synchronous bridge rectifier at ACP.
BSTN	C1	Boost Capacitor for internal driver for synchronous bridge rectifier at ACP.
ZTP0	F6	ASK Modulation FET at ACP.
ZTN0	F1	ASK Modulation FET at ACN.
ZTP1	G6	ASK Modulation FET at ACP.
ZTN1	G1	ASK Modulation FET at ACN.
AVDD	F5	Internal 5V Power Supply.
DVDD	F2	Internal 1.8V Power Supply.
AVDD_AUX	НЗ	5V Auxiliary Power Supply
GPOD0~7	H6, H5, I3, H2, H1,	General Purpose I/O. Type: Open Drain.
	F4, G3, G4	For more details, see Section 5.3.
GPIO0~5	GPIO0~5 14, 15, 16, 12, 11, H4 General Purpose I/O. Type: Push/Pull.	
		For more details, see Section 5.3.

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5.3 I/O Pin Default Configurations

GPOD0~7					
GPOD0:	Power good. This is to indicate to AP that wireless power is ready.				
GPOD1:	Interrupt. This is interrupt from wireless power to AP.				
GPOD2:	General GPIO.				
GPOD3:	I ² C slave SCL.				
GPOD4:	I ² C slave SDA.				
GPOD5:	General GPIO.				
GPOD6:	General GPIO.				
GPOD7:	General GPIO.				
Note: GPOD0~7 can be re-configured upon customer's request.					

	GPIO0~5
07:00	
GPIO0:	I ² C master SCL.
GPIO1:	I ² C master SDA.
GPIO2:	General GPIO, ADC.
GPIO3:	General GPIO. Note: Dedicated current sense for Tx demodulation.
GPIO4:	General GPIO. Note: Dedicated voltage sense for Tx demodulation.
GPIO5:	General GPIO, ADC.
Note: GPIC	00~5 can be re-configured upon customers' request.

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6 SPECIFICATIONS

6.1 Absolute Maximum Ratings

-0.3V to 30V
-0.3V to ACP+6V, ACN+6V
-0.3V to 30V
-0.3V to 30V
-0.3V to 6V
-0.3V to 6V
-0.3V to 2V
-55°C to 150°C
260°C

6.2 ESD Ratings

Test Model	Pins	Ratings
НВМ	All pins	(TBD) V
CDM	All pins	(TBD) V

6.3 Recommended Operating Conditions

Operating Temperature(Environment)	-40°C ~85°C
Operating Current (lout)	0 ~ 1.5A
Operating Voltage (Vrect)	3.5V ~ 20V

6.4 Thermal Information (Package Thermal Data)

	Junction to ambient (ReJA)	50°C	;/W
•			

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6.5 Electrical Characteristics

(Test conditions: V_{RECT}=12V, T_A=25°C, unless otherwise stated.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
Start-up (VDD pin)							
UVLO	Under Voltage Lockout	VRECT rising from 0V		2.95		V	
U _{VLO_HYS}	Under Voltage Lockout Hysteresis VRECT falling			200		mV	
Supply Current					*		
Iq	Quiescent Current			6		mA	
Bridge Rectifier	r			40	XX		
Rds(on)	Rds(on) of Power MOSFETs			40		mΩ	
Over-Voltage Pi	rotection						
	DC Over-Voltage	Rising voltage			20	V	
V _{OVP-DC}	Protection(programmable)				30	V	
LSB_Vovp	Least Significant Bitat OVP		O.	550		mV	
LDO							
VOUT	Output Voltage Regulation	Vrect = 8V, lout = 0A		5		V	
LCD VOLIT	Least Significant Bit when			25		\/	
LSB_VOUT	programming output voltage			25		mV	
Programming				2 20		V	
_Range				3~20		V	
ILimit_max	Output Current Limit	C			2	Α	
LCD II imit	Least Significant Bit when			25		m ^	
LSB_ILimit	programming output current limit			25		mA	
ADC							
N	Resolution			12		Bit	
f _{Sample}	Sampling Rate			100		kS/s	
Channel	Number of Channels			8			
Miscellaneous							
AVDD	AVDD Output Voltage			5		V	
AVDD_AUX	AVDD Auxiliary Input Voltage		4.5			V	
DVDD	DVDD Output Voltage			1.8		V	
Digital I/O Pins							
	HIGH Level Input Voltage V _{IH}		1.26			V	
	LOW Level Input Voltage V _I ∟				0.54	V	
GPOD0~7	LOW Level Output Voltage Vol			0		V	
	LOW Level Output Current lol	Test at VoL=0.4V	2/8	4.4/17 ^①		mA	
	Analog Input Range			0~2.4		V	
	HIGH Level Input Voltage V _ℍ		3.5			V	
GPIO0~5	LOW Level Input Voltage VIL				1.5	V	
	HIGH Level Output Voltage Vон			5		V	





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	LOW Level Output Voltage Vol			0	V
	HIGH Level Output Current Iон	Test at VoH=4V	2/8	7.8/29 ^①	mA
	LOW Level Output Current IoL	Test at VoL=0.4V	2/8	4.4/17 ^①	mA
	Analog Input Range			0~5	V
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6.6 Typical Operating Characteristics

The following performance characteristics were taken using MT5815 wireless power transmitter at $T_A=25^{\circ}C$, unless otherwise noted.

Figure 1. Efficiency vs. Output Load: Vout=5V

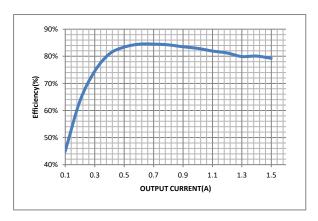


Figure2. Efficiency vs. Output Load: Vout=9V

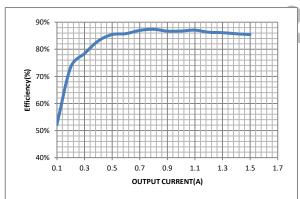


Figure 3. Efficiency vs. Output Load: Vout=12V

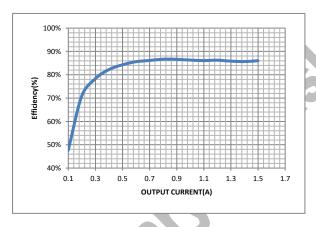


Figure 4. Efficiency vs. Output Load: Vout=15V

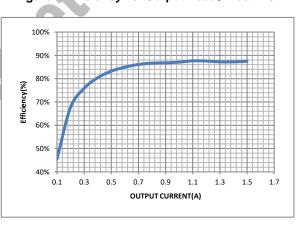


Figure 5. Efficiency vs. Output Load: Vout=18V

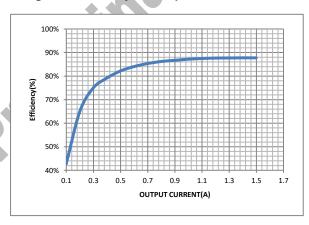
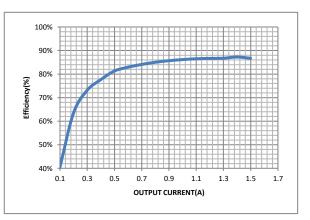


Figure 6. Efficiency vs. Output Load: Vout=20V



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Figure 7. Load Reg. vs. Output Load: Vout=5V

5.4 5.3 5.2 (A) 5.1 5 0 4.9 4.9 4.7 Preliminary Datasheet Confli

Figure8. Enable Startup: Vout=5V; lout=1A



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7 DETAILED DESCRIPTIONS

7.1 Overview

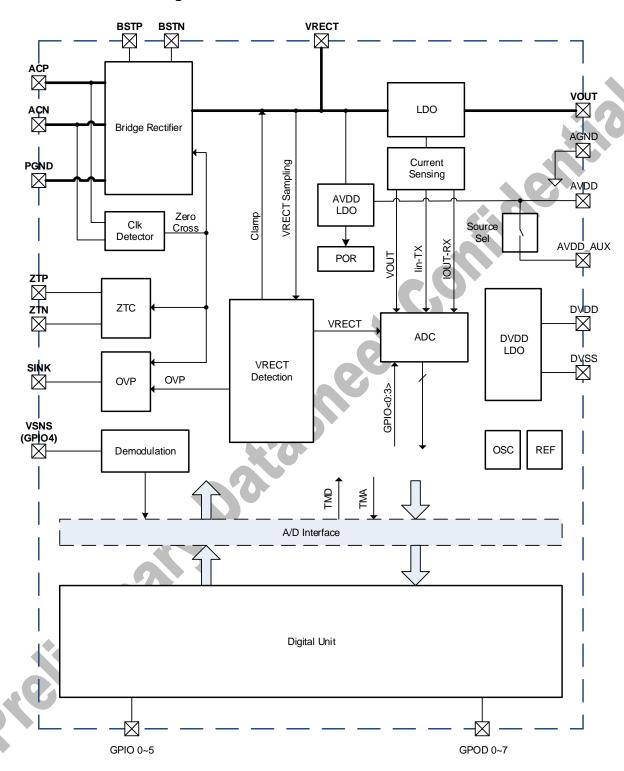
MT5725 is an SoC (System on Chip) for wireless power receiver. It only needs several passive components like power receiving coils, resonant tank capacitors, decoupling capacitors and pull up/down resistors to build a complete wireless power receiver system. When coupled with a wireless power transmitter, this system can provide all the functions for wireless power transfer, including power receiving and rectification, output regulation, communication for power control and data exchange, and abnormal condition (FOD, over voltage, current, temperature, etc.) protection.

MT5725 is by default programmed to be fully compliant with the latest WPC Qi Specification Version rs' propriec 1.2.4 with support of both BPP (Baseline Power Profile) and EPP (Extended Power Profile). It can also be programmed to be compliant with major smart phone vendors' proprietary fast wireless charging

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7.2 Functional Block Diagram





7.3 Theory of Operation

MT5725 is composed of several major functional blocks which together achieve the wireless power receiving function.

Bridge Rectifier, which is also called Full Synchronous Rectifier. This block converts the received AC power from the resonant tank to DC power with the help of the capacitors connected on its output.

LDO, which is also called Main LDO or Output LDO. This block functions as a load switch (connecting and disconnecting the external load), output voltage and current regulation and output clamping when fast load/line transient happens.

AVDD and DVDD LDO and POR. These blocks provide the necessary regulated power supplies from rectifier output for the operation of the chip.

ZTC and CLK Detector. These blocks are for the bi-directional communication for power control and data exchange.

OVP and Vrect Detection. These blocks are for the rectifier output voltage detection and over voltage protection when Vrect is too high.

OSC and REF. These blocks provide the timing reference and voltage reference for the whole chip.

ADC. This block is one of the key blocks that convert various measured analog variables (voltages, currents, temperature, external analog inputs, etc.) to digital domain such that the embedded micro controller can use the information for follow up actions.

Digital Unit. This block contains all the digital circuits, which include embedded micro controller, volatile and nonvolatile memories, I2C interface, peripherals, DMA (Direct Memory Access), internal buses, and other digital functional blocks. This block is the brain of the whole chip which dynamically configures chip for different functions in different state, communicate with the outside world (power transmitter and receiver side external host), and perform necessary data processing for proper operation (like FOD calculation, target Vrect and Vout calculation, etc.)



7.4 Device Function Modes

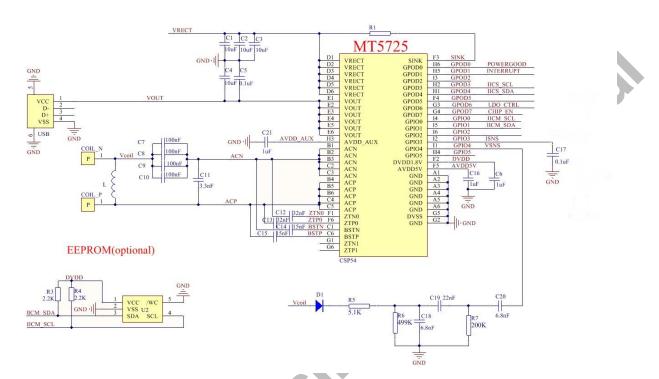
an be ...itter the ...ost (e.g., an ...des: MT5725 can be programmed to operate in different modes. The switching among these modes can be

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8 APPLICATIONS AND IMPLEMENTIONS

8.1 Reference Schematic



8.2 **BOM**

#	Reference	Value	Description	Footprint	Quanti
1	R1	50R	RES SMD 50R 5% 1/8W	0805	1
2	R3, R4	2.2K	RES SMD 2.2K 5% 1/20W	0201	2
3	R5	5.1K	RES SMD 5.1K 5% 1/20W	0201	1
4	R6	499K	RES SMD 499K 5% 1/20W	0201	1
5	R7	200K	RES SMD 200K 5% 1/20W	0201	1
6	C1, C2, C3, C4	10uF	CAP CER 10UF 25V X7R 0603	0603	4
7	C5	0.1uF	CAP CER 0.1UF 25V X7R 0603	0603	1
8	C6,C16,C21	1uF	CAP CER 1UF 6.3V X7R 0201	0201	3
9	C7,C8,C9,C10	100nF	CAP CER 0.1UF 50V X7R 0603	0603	4
10	C11	3.3nF	CAP CER 0.0033UF 50V X7R	0402	1
11	C12,C13	32nF	CAP CER 0.032UF 50V X7R 0402	0402	2
12	C14,C15	15nF	CAP CER 0.015UF 50V X7R 0402	0402	2
13	C17	0.1uF	CAP CER 0.1UF 6.3V X7R 0201	0201	1
14	C18	6.8nF	CAP CER 6.8nF 50V X7R 0201	0201	1
15	C19	22nF	CAP CER 22UF 50V X7R 0201	0201	1
16	C20	6.8nF	CAP CER 6.8nF 6.3V X7R 0201	0201	1
17	D1	BAV21WS	Diode	SOD-123	1

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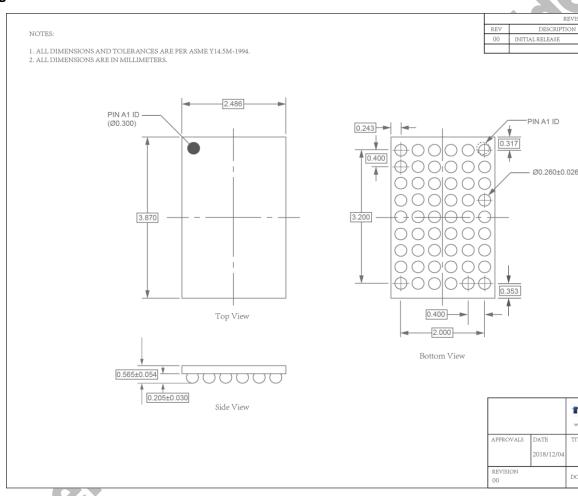
18	U1	MT5725	Wireless power receiver	CSP54	1
19	U2	M24128	EEPROM	UFDFP	1
				Notes	30

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9 DETAILED PACKAGING INFORMATIONS

9.1 WLCSP Package Outline and Dimensions



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10 ORDERING INFORMATION

Part No.	Package	Package Information	Package	Ambient	Chip Mark	
Part NO.	Туре	Package information	Quantity	Temperature	Chip Mark	
					ma∳ic	
MT5725	WLCSP	2.48 x 3.87mm 54-WLCSP	3000	-40°C~+85°C	MT5725	
W113723					YYWWXX	
					XXXX	

11 REVISION HISTORY

Revision	Date	Description
1.0	2019-04-19	Preliminary version.

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